

SEMICONDUCTOR TECHNICAL DATA

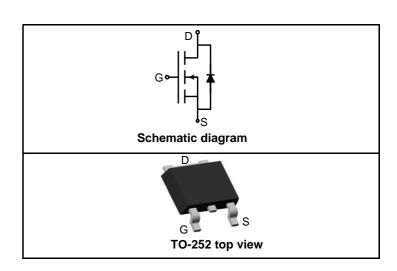
FTK4015D

Main Product Characteristics:

V_{DSS}	-40V		
R _{DS} (on)	11mΩ (typ.)		
I _D	-20A		

Features and Benefits:

- Advanced trench MOSFET process technology
- Special designed for PWM, load switching and general purpose applications
- Ultra low on-resistance with low gate charge
- High Power and current handing capability
- 175°C operating temperature



Description:

It utilizes the advanced trench processing techniques to achieve extremely low on resistance and low gate charge. These features combine to make this design an extremely efficient and reliable device for use in PWM, load switching and a wide variety of other applications.

Absolute max Rating:

Symbol	Parameter	Max.	Units
ID @ TC = 25°C	Continuous Drain Current, VGS @ 10V①	-20	
ID @ TC = 100°C	Continuous Drain Current, VGS @ 10V①	-16	Α
IDM	Pulsed Drain Current②	-50	A
ISM	Pulsed Source Current (Body Diode)②	-50	
PD @TC = 25°C	Power Dissipation③	75	W
VDS	Drain-Source Voltage	-40	V
VGS	Gate-to-Source Voltage	± 20	V
EAS	Single Pulse Avalanche Energy @ L=0.1mH	40	mJ
IAS	Single Pulse Avalanche Current @ L=0.1mH	28	А
Tj and Tstg	Operating Junction and Storage Temperature Range	-55 to + 175	°C

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Thermal Resistance

Symbol	Characterizes	Value	Unit
$R_{ heta JA}$	Junction-to-ambient (t ≤ 10s) ④	14	°C/W
	Junction-to-Ambient (PCB mounted, steady-state) ④	40	°C/W
Reuc	Maximum Junction-to-Case (5)	2	°C/W

Electrical Characterizes $@T_A=25^{\circ}C$ unless otherwise specified

Symbol	Parameter	Min.	Тур.	Max.	Units	Conditions	
BVDSS	Drain-to-Source breakdown voltage	-40		ı	V	VGS = 0V, ID = 250μA	
RDS(on)	Static Drain-to-Source	_	11	15		VGS=10V, ID = 12A	
		_	14.3	_		TJ = 125℃	
	on-resistance	_	18.5	25	mΩ	VGS=4.5V, ID = 8A	
		_	23.6	_		TJ = 125℃	
VGS(th)	Gate threshold voltage	-1		-3	V	VDS = VGS, ID =250uA	
	Drain-to-Source leakage	_	_	-1		VDS =-40V,VGS = 0V	
IDSS	current	_	_	-5	μΑ	TJ = 55°C	
IGSS	Gate-to-Source forward leakage	_	_	100	nA ·	VGS =20V	
1000	Gate-to-Source reverse leakage	-100		_		VGS = -20V	
G(fs)	Forward transconductance	5	27	_	S	VDS=-5V,ID=-12.0A	
Qg	Total gate charge	_	57.4	40		ID 204	
Qgs	Gate-to-Source charge	_	10.8	6	nC	ID=-20A, VDD=-12V,	
Qgd	Gate-to-Drain("Miller") charge	_	11.9	15		VGS=-10V	
td(on)	Turn-on delay time	_	15.2		VDD=-18.8V,ID=-12.5 - ns RL=1.50Ω,RG=3.00Ω, VGS=-10V	VDD=-18.8V,ID=-12.5A,	
tr	Rise time	_	23.7				
td(off)	Turn-Off delay time	_	53.3				
tf	Fall time	_	12.7			VG3=10V	
Ciss	Input capacitance	_	5188	_	Vds=-20V, Vgs=0V, f=1MHZ	\/ds=-20\/	
Coss	Output capacitance		376	_		Vgs=0V,	
Crss	Reverse transfer capacitance	_	293	_			

Revision No: 0

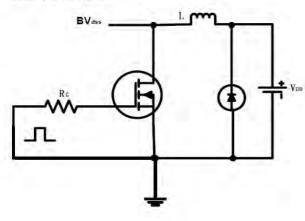


Source-Drain Ratings and Characteristics

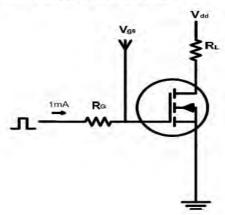
Symbol	Parameter	Min.	Тур.	Max.	Units	Conditions
IS	Maximum Body-Diode Continuous Curren	_	20	_	А	
VSD	Diode Forward Voltage	_	-0.74	1.2	V	TJ=25°C,IS=-1A,VGS=0V

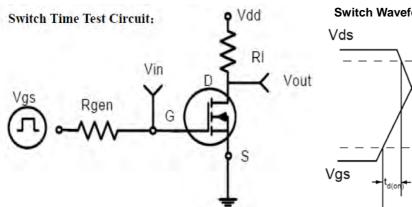
Test circuits and Waveforms

EAS test circuits:

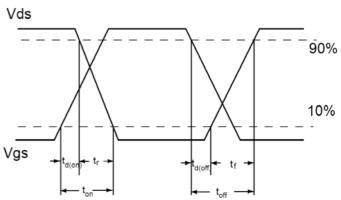


Gate charge test circuit:





Switch Waveforms:



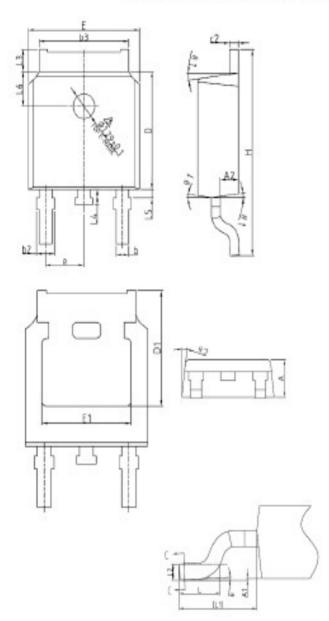
Notes:

- ①The maximum current rating is limited by bond-wires.
- ②Repetitive rating; pulse width limited by max. junction temperature.
- ③The power dissipation PD is based on max. junction temperature, using junction-to-case thermal resistance.
- ⓐThe value of R_{θJA} is measured with the device mounted on 1in 2 FR-4 board with 2oz. Copper, in a still air environment with TA =25°C
- ⑤These curves are based on the junction-to-case thermal impedence which is measured with the device mounted to a large heatsink, assuming a maximum junction temperature of TJ(MAX)=175°C



Mechanical Data:

TO-252E-2-M PACKAGE INFORMATION



Dimensions in Millimeters

SYMBOL	MIN	NOM	MAX		
A	2.20	2.30	2.38		
A1	0	-	0.10		
A2	0.90	1.01	1.10		
b	0.72	_	0.85		
b1	0.71	0.76	0.81		
b2	0.72	-	0.90		
b3	5.13	5.33	5.46		
C	0.47	-	0.60		
c1	0.46	0.51	0.56		
c2	0.47	-	0.60		
D	6.00	6.10	6.20		
D1	5.25	_	_		
E	6.50	6.60	6.70		
E1	4.70	-	-		
e	2.186	2.286	2.386		
Н	9.80	10.10	10.40		
L	1.40	1.50	1.70		
L1	2	2.90REF	10		
L2	0.51BSC				
L3	0.90	_	1.25		
L4	0.60	0.80	1.00		
L5	0.15	-	0.75		
L6	1.80REF				
θ	0,	_ =	8,		
θ1	5'	7'	9.		
θ 2	5'	7'	9.		

